



DB101S THRU DB107S

Surface Mount Bridge Rectifier

Features

- ★ Low forward voltage drop
- ★ High current capability
- ★ High surge current capability

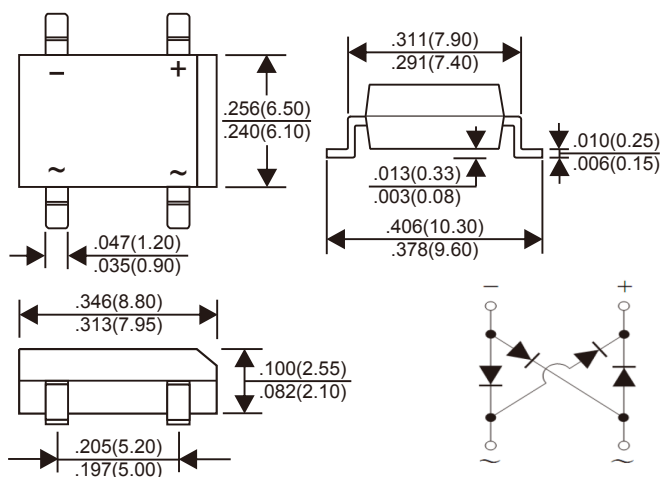
Mechanical Data

- ★ Case: Molded plastic, DB-S
- ★ Epoxy: UL 94V-0 rate flame retardant
- ★ Terminals: Solderable per MIL-STD-202, method 208
- ★ Polarity: As marked on Body
- ★ Mounting position: Any

Voltage Range 50 to 1000 V

Current 1.0 Ampere

DB-S



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

PARAMETER	SYMBOL	DB101S	DB102S	DB103S	DB104S	DB105S	DB106S	DB107S	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current @ $T_C=100^\circ\text{C}$	$I_{F(AV)}$	1.0							A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	30							A
Maximum instantaneous forward voltage @ $I_F=1.0\text{A}$	V_F	1.1							V
Maximum DC reverse current at rated DC blocking voltage @ $T_A=25^\circ\text{C}$ @ $T_A=125^\circ\text{C}$	I_R	5 200							μA
Typical junction capacitance (Note 1)	C_J	25							pF
Typical thermal resistance from junction to ambient (Note 2)	$R_{\theta JA}$	40							$^\circ\text{C/W}$
Typical thermal resistance from junction to lead (Note 2)	$R_{\theta JL}$	15							$^\circ\text{C/W}$
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150							$^\circ\text{C}$

NOTES : (1) Measured at 1.0 MHz and applied reverse voltage of 4.0 Volts DC.

(2) Mounted on glass epoxy PCB board with 1.3 mm x 1.3 mm solder pad.

RATINGS AND CHARACTERISTICS CURVES DB101S THRU DB107S

Fig.1 - Forward Current Derating Curve

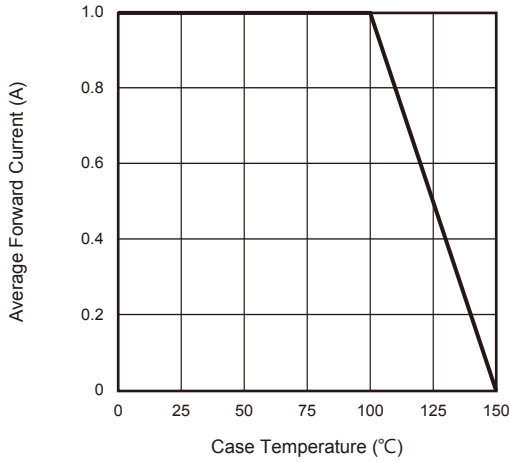


Fig.2 - Maximum Non-Repetitive Peak Forward Surge Current

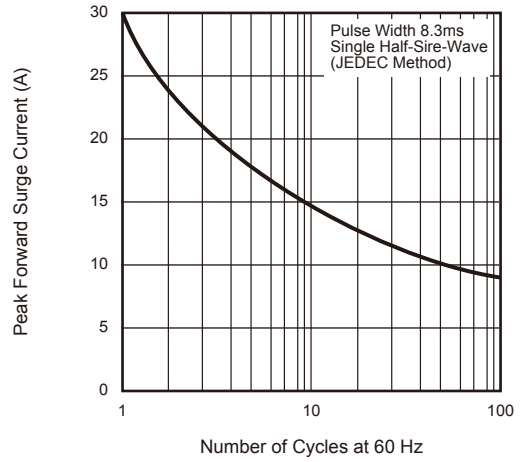


Fig.3 - Typical Instantaneous Forward Characteristics

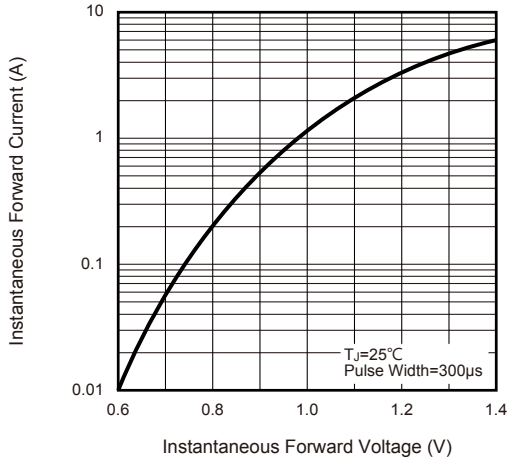


Fig.4 - Typical Reverse Leakage Characteristics

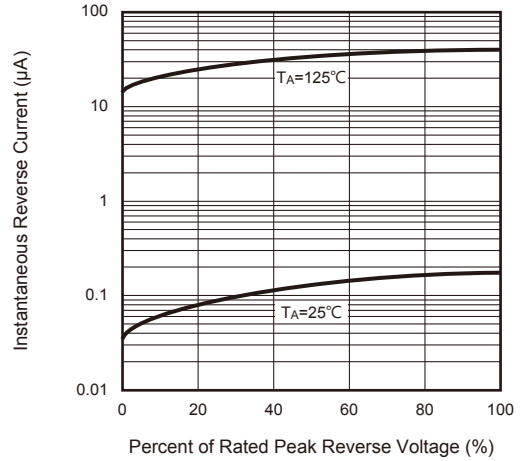


Fig.5 - Typical Junction Capacitance

